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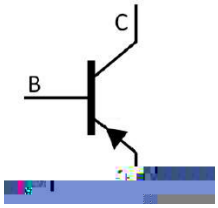
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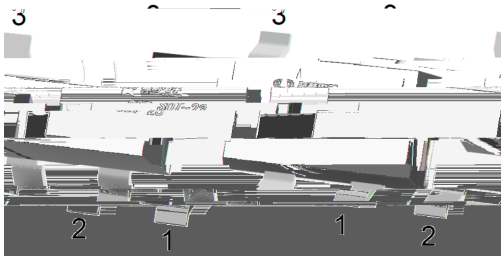
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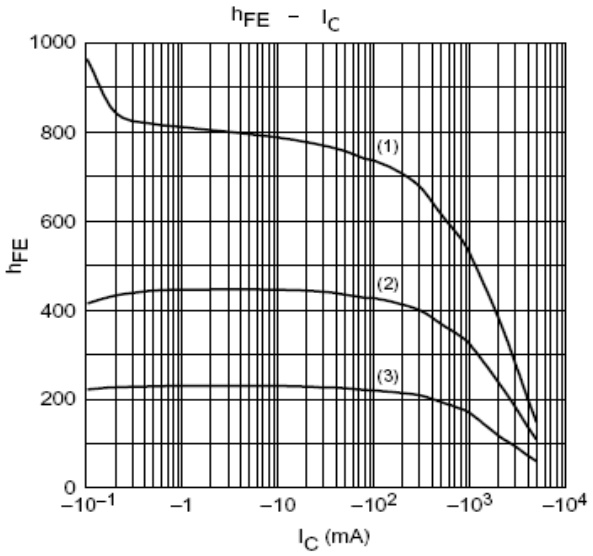


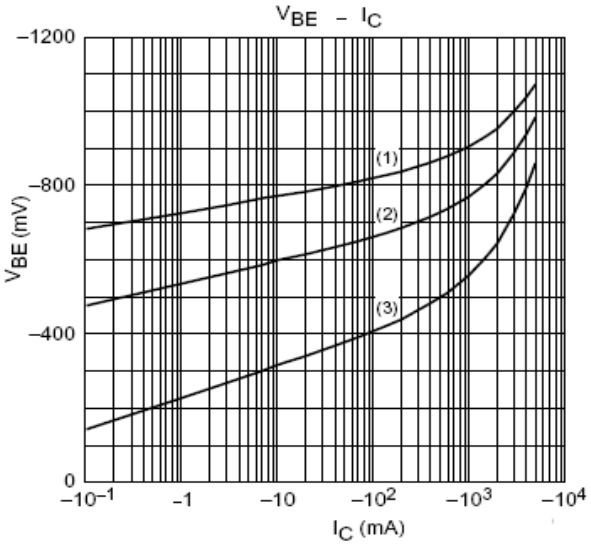
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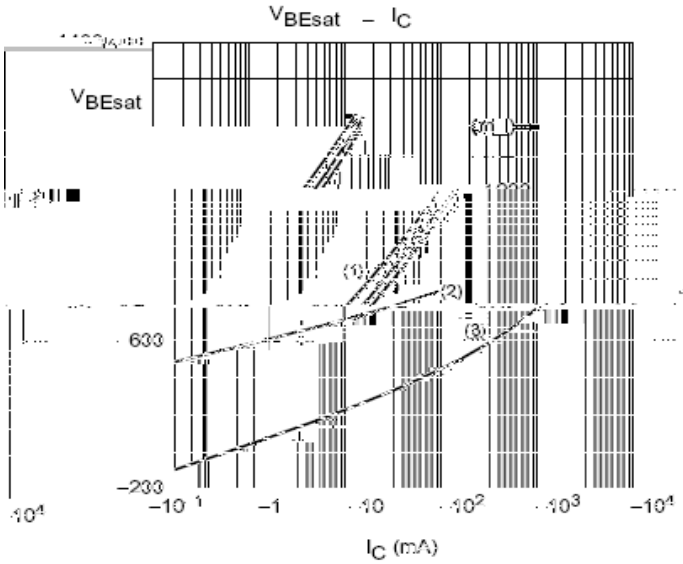
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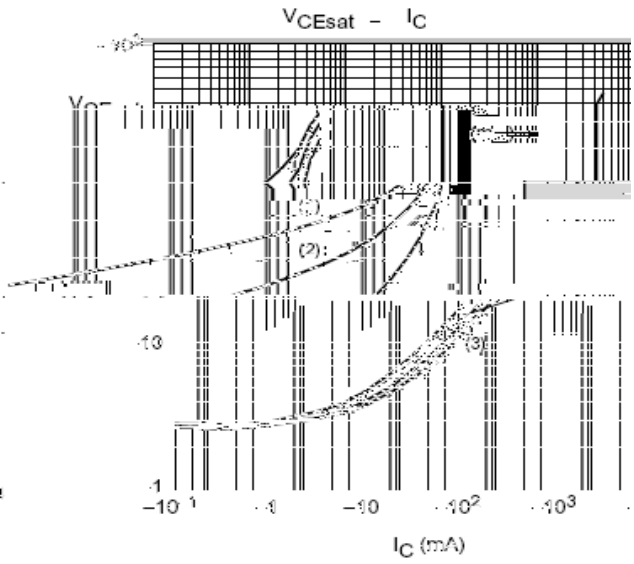
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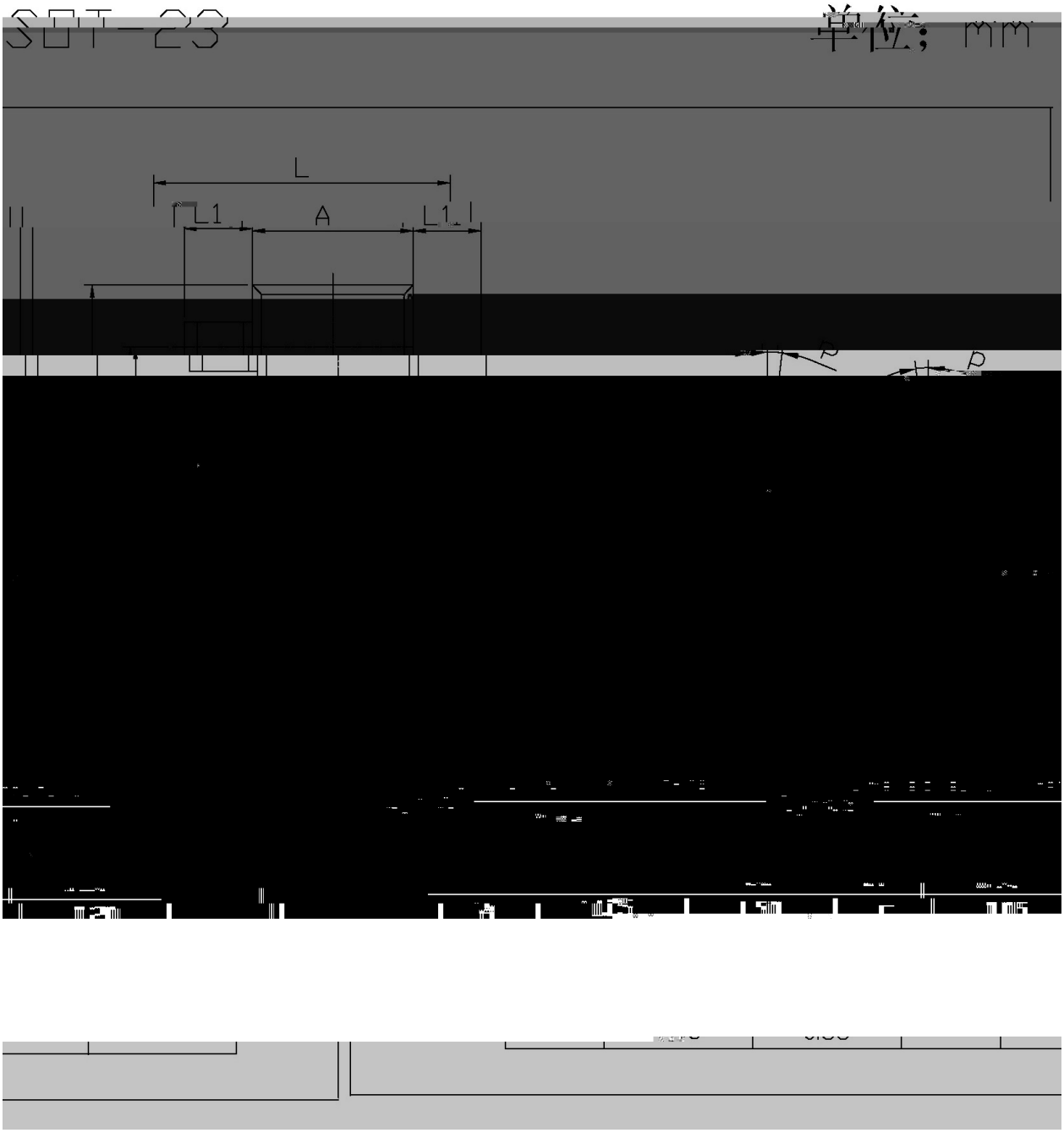




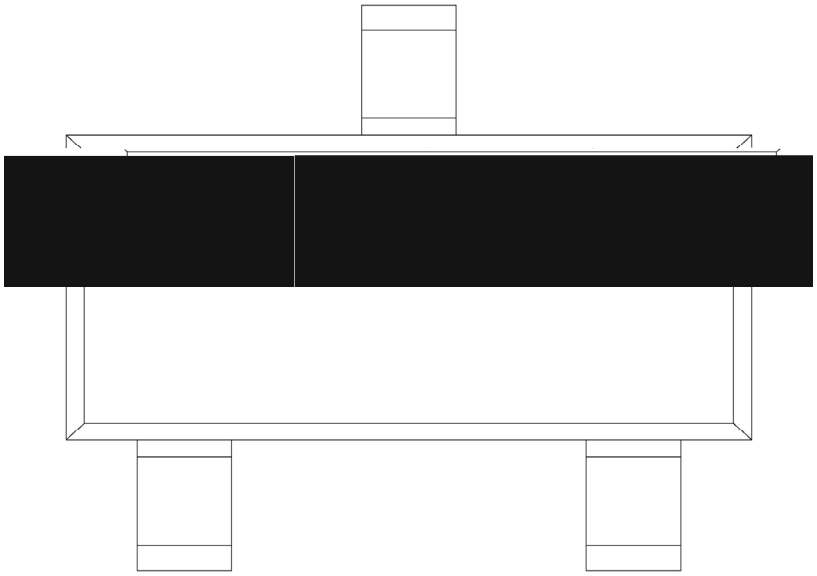




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ÂD /Cã p ¯ »] ***/*** **Resistance to Soldering Heat Test Conditions**

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